" Docket No.:

LT-0050

## **DECLARATION AND POWER OF ATTORNEY**

| As a below named inventor, I her   | eby declare that:   |   |   |
|--|---|---|---|
| My residence, post office and citi   | zenship are as stated below next to n   | ay name,  |   |
| are listed below) of the subject m   | nd sole inventor (if only one name is<br>atter claimed and for which a patent<br>IPUTER SYSTEM, the specification | is sought on the inven  | riginal, first and joint inventor (if plural name: tion entitled_DEVICE AND METHOD FOR  |
| [X] is attached hereto   | was filed on as<br>ended on   | s Application Serial No   | o and was<br>ble)   |
| I hereby state that I have reviewe any amendment referred to above   | d and understand the contents of the<br>2.  | e above identified spec   | cification, including the claims, as amended by   |
| I acknowledge the duty to disclos<br>Federal Regulations, Section 1.56                                       | e information which is known to me  | e to be material to pate  | entability in accordance with Title 37, Code o  |
| certificate, or 365(2) of any PCT<br>listed below and have also identif                                      | international application which design  | gnated at least one cou<br>foreign application for                          | oreign application(s) for patent or inventor's intry other than the United States of Americal patent or inventor's certificate, or of any PCI is claimed.   |
| Prior Foreign Application(s):<br><u>Number</u>   | Country   | Foreign Filing Month/Day/   |   |
| 10-2003-0036695  | Republic of Korea   | July 9, 2003  |   |
| I hereby claim the benefit under :   | 35 U.S.C. 119(e) of any United States   | s provisional application   | on(s) listed below.   |
| Application Number(s):   |   | Filing Date (Month/Day/Year)  |   |
| designating the United States of<br>disclosed in the prior United States<br>acknowledge the duty to disclose | America, listed below and, insofar a<br>tes or PCT international application                                      | as the subject matter of<br>in the manner provide<br>patentability as defin | 365(c) of any PCT international application of each of the claims of this application is not ded by the first paragraph of 35 U.S.C. 112, ned in 37 CFR 1.56 which became available late of this application. |
| Prior U. S. Application or PCT Parent Number   | Filing Date (Month/I  | Day/Year)   | Parent Patent Number (if applicable)  |

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Carol L. Druzbick, Registration No. 40,287; Anthony H. Nourse, Registration No. 46,121; Laura L. Lee, Registration No. 48,752; Rene A. Vazquez, Registration No. 38,647; Donald R. McPhail, Registration No. 35,811; Timothy M. Speer, Registration No. 47,355; Ruay L. Ho, Registration No. 48,110; and Samuel W. Ntiros, Registration No. 39,318, all of

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them. Full name of sole or first inventor. Jang Geun OH 是极 Inventor's signature: Date: Mar. 16. 2004 Mailing Address: 708-1150, Sinwoo Apt., Gwonsun-dong, Gwonsun-gu, Suwon-si, Kyonggi-do, 441-390, Korea Citizenship: Republic of Korea Residence Address (only if different from mailing address): Full name of joint inventor(s): Inventor's signature: Date: Mailing Address: Citizenship: Republic of Korea Residence Address (only if different from mailing address): Full name of joint inventor(s): Inventor's signature:

Date:

Residence Address

Mailing Address:

Citizenship:

(only if different from mailing address):